Optimization of Current Equipment for Lead Free Soldering of Electric and Electronic Components

Dias Lopes

ISQ Profile

- Founded in 1965;
- Privately owned, being a non profit technical and scientific association;
- Two hundred company members;
- Arround 600 staff teamed with customers and partners;
- Turnover: 41 M€ (2002);
- Operating in 20 countries worldwide









ocation

Portugal

Headquarter: Taguspark, Oeiras

Delegations: Porto, Sines, Castelo Branco

Braga, Viseu, Leiria, Loulé Offices:

Brasil

Rio de Janeiro

Belo Horizonte

Macaé

México

Cidade do México

França

Saint-Genis-Pouilly

R. P da China

Beijing

Macau

Angola Luanda

Cuba

Havana

Turquia

Ankara



Network

Main Activities Areas

Technical Inspections Assistance **Technical** **Civil Infrastructure**

Metallic Construction

Maintenance and Structural Integrity

Metrology

Electrical equipments and installations

Lift and transportation equipment

Pipelines

Quality management

Information Technologies

Environmental Assessment and monitoring

Industrial Health and Safety

Production Technologies

Logistics

Maintenance & Quality Assurance

Research and Development

Training E-technologies

ASO A PARTY NAMED IN COLUMN

Markets

Government services

Aerospace Industry
Cement
Civil Infrastructure
Dairy and Agro-Food Industry

Manufacturing
Industry
Mining & Metals
Paper & Pulp
Petroleum & Chemical
Pipeline
Power





Laboratories

LABCAB

Laboratory of Electrical Cables Testing

LABEL

Laboratory of Electrical Equipments Testing

LABEND

Laboratory of Non Destructive Testing

LABET

Laboratory of Thermo Dynamical Testing

LABMEC

Laboratory of Mechanical Behaviour

LABMETRO

Laboratory of Metrology

LABMM

Laboratory of Metallurgy and Materials

LABQUI

Laboratory of Environment and Chemistry

LABRD

Laboratory of Acoustic & Noise Testing

Other Laboratories (Non accredited):

Laboratory of Concrete Testing

Laboratory of Anticorrosion Protective Coatings

Laboratory of Electromagnetic Compatibility Testing

ASD A PARTY NAMED IN

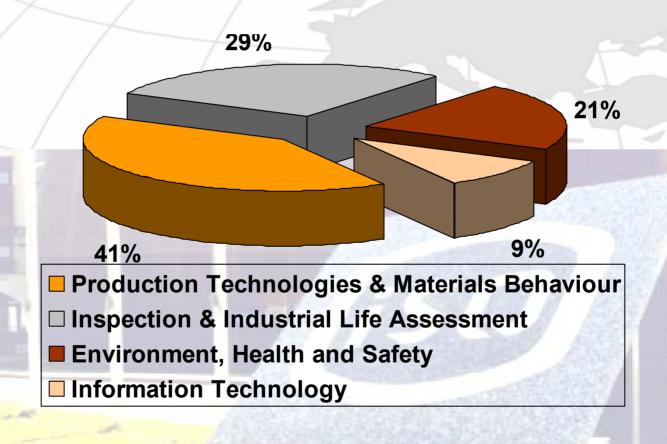
R&D in ISQ – Some Participating Programmes

- BOLIVAR
- BRITE EURAM
- CECA
- CERN
- CRAFT
- ENVIRONMENT
- ESPRIT

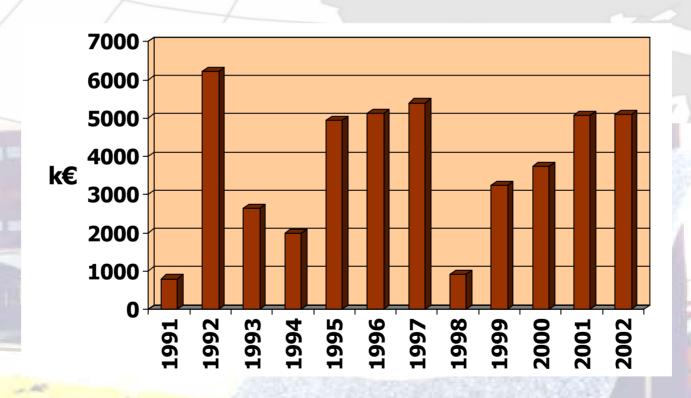
- ISIS
- ISPO
- NATO
- PEDIP
- POE
- SAVE
- SMT
- SPRINT

- TTV/TVP
- ASIA IT&C
- ENVIREG
- EUREKA
- GROWTH
- INNOVATION
- 6th FRAMEWORK

Thematic Areas - Distribution

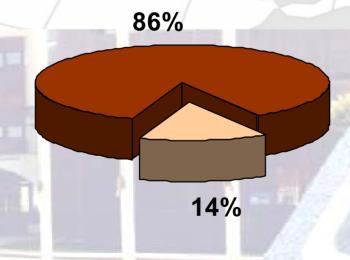


Investment in the last years









■ International Projects

National Projects

Partnerships

Companies, Institutes and Universities

- International Partners
 - ~ 1000
 - ~ 22 different countries
- National Partners
 - ~ 120

- ANIMEE (Portuguese Association of Manufacturing of Electric and Electronic Equipment) represents the core business of main industries in Portugal:
 - 116 companies
 - 43000 workers
 - Turnover (2002): 4600 M€ / ~ 80% exportation

Other Companies Related to Electric/Electronic Devices

- End users (e.g. OGMA, TAP)
- New areas (aerospace companies)

ISQ Expertise in Electric and Electronic Equipment

- Acreditated Lab's for electric and electronic compliance
- Large expertise on Quality Management and Quality Assurance
- Expertise on Lyfe Cycle Assessment
- Waste Management Consultancy of Electric and Electronic components
- Expertise on joining technologies

ISQ Participation in R&D Electronic and Electrical Related Projects

- Joining of Cooper and Aluminium Alloys by Laser (JOCAL)
- Conductive adhesives as a solder alternative in surface mount and multiship module technology
- European Lead-Free Soldering Network (ELFNET)
 Approved contract phase
- Low Cost Lead-Free Soldering Technology to Improve Competitiveness of European SME (LEADOUT)
 Approved - contract phase

Detected Needs for R&D in Portugal and EU

- Management of the implementation from of Lead to Lead Free Soldering
- Analysis of existing equipment requirements behaviour to the Lead Free Soldering
- Quality assessment of components
- Process Window: Development and optimisation of Lead Free Process (Yield Point)

"Optimisation of Current Equipments for LEAD FREE Soldering of Electric and Electronic Components – SOLDERING 2006"

Project Proposal Overview

WORKPACKAGE 1

Selection of Soldering Technologies: Wave, Reflow, Laser

WORKPACKAGE 2

Selection of Typical Components

WORKPACKAGE 4

Laboratory and Industrial Trials

WORKPACKAGE 5

Optimisation of Solutions

WORKPACKAGE 3

Selection of LEADFREE Solders

WORKPACKAGE 6

Joint Evaluation

WORKPACKAGE 7

Implementation of Optimised Solutions

WORKPACKAGE 8

Evaluation of Final Solutions

September 19, 2003 – Lisbon, Portugal

Technical Workshop – Integrating Comon Problems for Shared Solution





ACQUIRED

- C3P
- ISQ
- INEGI
- ITB, INC. / NASA

POTENTIAL

- IAG'S (e.g. ANIMEE,...)
- INDUSTRIES (e.g. EFACEC, PHILIPS, PIONNEER, DELPHI,...)
- SMEs (e.g. SILGAL, STONE, TELCA, TEKELEC,...)
- UNIVERSITIES (e.g. IST, FEUP,...)
- RTD Centers (e.g. INESC,...)

Procurement of Funding

- Companies Sponsorship
- National Programmes (e.g. POCTI, PRIME)
- EU Programmes (6th FP)

Conclusions / Next Steps

- Build up the consortium
- Finalize the proposal
- Procurement of financial resources
- Submission of the proposal